

SEMITOP[®]4

3-phase bridge rectifier + brake chopper + 3-phase bridge inverter SK 25 DGDL 126 T

Preliminary Data

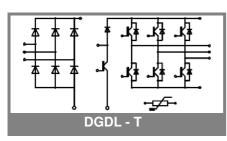
Features

- One screw mounting module
- Fully compatible with SEMITOP[®]1,2,3
- Improved thermal performances
 by aluminium oxide substrate
- Trench IGBT technology
- CAL technology free-wheeling diode
- Integrated NTC temperature sensor

Typical Applications*

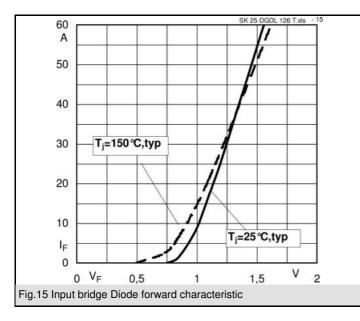
- Inverter up to 16 kVA
- Typ. motor power 7,5 kW

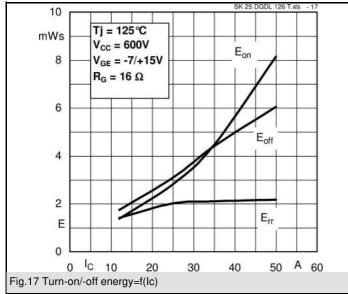
1) $V_{CE,sat}$, V_F = chip level value

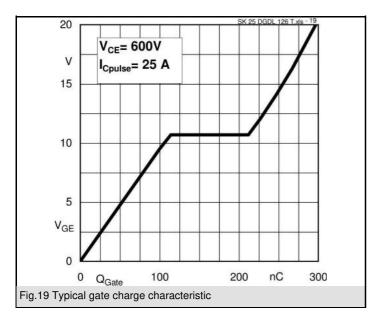


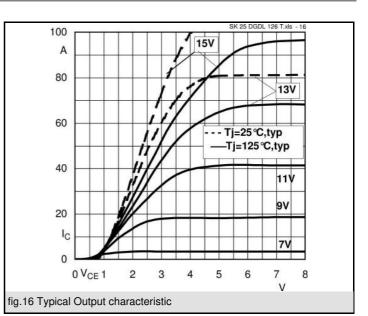
Absolute Maximum Ratings		Ts = 25 °C, unless otherwis	e specified
Symbol Conditions		Values	Units
IGBT - In	verter,Chopper		
V _{CES}		1200	V
I _C	T _s = 25 (70) °C	41 (31)	А
I _{CRM}	I_{CRM} = 2 x I_{Cnom} , t_p = 1 ms	50	A
V _{GES}		± 20	V
T _j		-40 +150	°C
Diode - Ir	verter,Chopper		•
I _F	T _s = 25 (70) °C	30 (22)	A
I _{FRM}	$I_{FRM} = 2xI_{Fnom}, t_p = 1 \text{ ms}$	50	A
Т _ј		-40 +150	°C
Rectifier	-		•
V _{RRM}		1600	V
I _F	T _s = 70 °C	35	A
I _{FSM} / I _{TSM}	t _p = 10 ms , sin 180 ° ,T _i = 25 °C	370	A
l² _t	t _p = 10 ms , sin 180 ° ,T _i = 25 °C	680	A²s
T _j		-40 +150	°C
T _{sol}	Terminals, 10 s	260	°C
T _{stg}		-40 +125	°C
V _{isol}	AC, 1 min. / 1 s	2500 / 3000	V

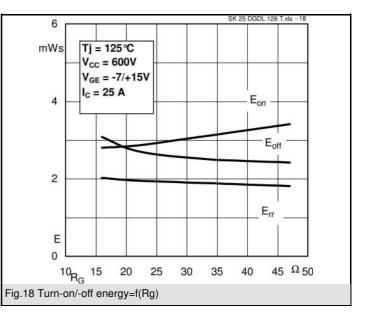
Characteristics		Ts = 25 °C	Ts = 25 °C, unless otherwise specified				
Symbol	Conditions	min.	typ.	max.	Units		
IGBT - In	verter	·					
V _{CEsat}	I _C = 25 A, T _i = 25 (125) °C		1,7 (2)	2,1 (2,4)	V		
V _{GE(th)}	$V_{GE} = V_{CE}, I_{C} = 1 \text{ mA}$	5	5,8	6,5	V		
V _{CE(TO)}	T _j = 25 °C (125) °C		1 (0,9)	1,2 (1,1)	V		
r _T	T _j = 25 °C (125) °C		28 (44)	36 (52)	mΩ		
C _{ies}	V _{CE} = 25 V _{GE} = 0 V, f = 1 MHz		1,8		nF		
C _{oes}	V _{CE} = 25 V _{GE} = 0 V, f = 1 MHz		0,095		nF		
C _{res}	$V_{CE} = 25 V_{GE} = 0 V, f = 1 MHz$		0,082		nF		
R _{th(j-s)}	per IGBT		0,9		K/W		
t _{d(on)}	under following conditions		82		ns		
t	V_{CC} = 600 V, V_{GE} = ± 15 V		21		ns		
t _{d(off)}	I _C = 25 A, T _j = 125 °C		426				
t _f	$R_{Gon} = R_{Goff} = 16 \Omega$		78		ns		
Eon	inductive load		2,8		mJ		
E _{off}			3,1		mJ		
Diode - Ir	nverter,Chopper	·					
V _F = V _{EC}	I _F = 20 A, T _i = 25(125) °C		1,5 (1,55)	1,65 (1,7)	V		
V _(TO)	T _i = 25 °C (125) °C		1,15 (1,1)	1,25 (1,2)	V		
r _T	T _i = 25 °C (125) °C		17,5 (22,5)	20 (25)	mΩ		
R _{th(j-s)}	per diode		1,7		K/W		
IRRM	under following conditions		25		Α		
Q _{rr}	I _F = 25 A, V _B = 300 V		5		μC		
E _{rr}	V _{GE} = 0 V, T _i = 125 °C		2		mJ		
	di _{F/dt} = 2100 A/µs						
Diode - R		1			I		
V _F	I _F = 25 A, T _i = 25() °C		1,1		V		
V _(TO)	T _i = 150 °C		0,8		V		
r _T	T _i = 150 °C		13		mΩ		
R _{th(j-s)}	per diode		1,5		K/W		
	tur sensor	1			I		
R _{ts}	5 %, T _r = 25 (100) °C		5000(493)		Ω		
Mechanio	cal data	I			<u> </u>		
w		1	60		g		
M _s	Mounting torque	2,5		2,75	Nm		

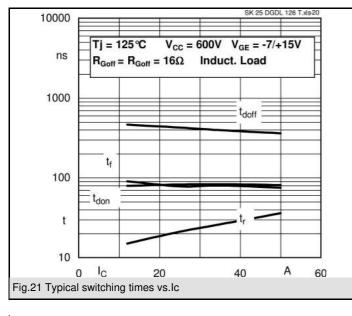


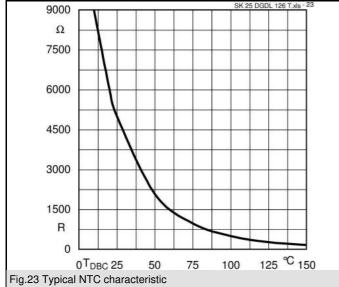


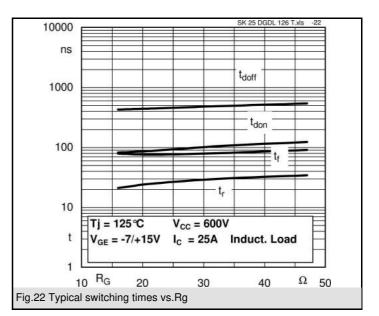


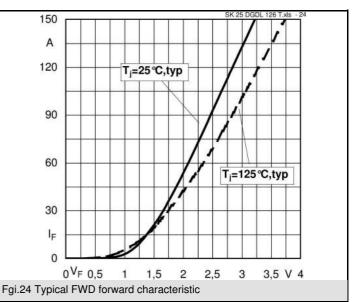






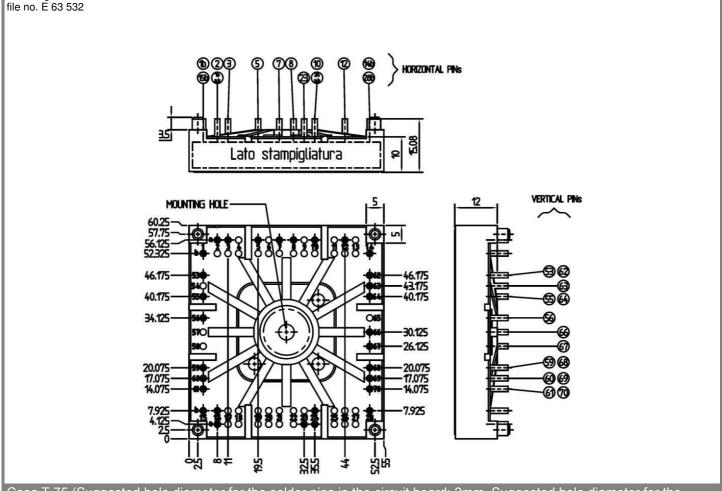


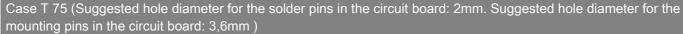


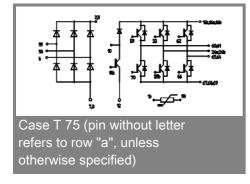


UL recognized

Dimensions in mm







This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.